



Notes:

1. Some parts will not be installed, see BOM file.
3. No Centroid Data provided. Assembly house shall generate it from Gerber Files if needed.

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES FRACTIONS DECIMALS ANGLES			CONTRACT NO.		UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP			
DO NOT SCALE DRAWING			APPROVALS	DATE	TITLE			
			M. Bogdan	5/11/2011	PSEC3 Flip Mezzanine Card Assembly drawing - Bottom			
			CHECKED	5/11/2011	SIZE	FIG. NO.	REV. NO.	REV.
			M. Bogdan		C		2730-Bot	A
SIMILAR TO			ACT. WT	CALC. WT	SCALE		SHEET 1 of 1	